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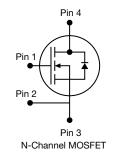


E Series Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	700				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.130			
Q _g max. (nC)	116				
Q _{gs} (nC)	19				
Q _{gd} (nC)	33				
Configuration	Single				

PowerPAK[®] 8 x 8





FEATURES

- Completely lead (Pb)-free device
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q_g)
- Avalanche energy rated (UIS)
- Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and Halogen-free	SiHH24N65E-T1-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage		V _{DS}	650	v		
Gate-Source Voltage	V _{GS}	± 30	v			
Continuous Drain Current (T, = 150 °C)	$V_{GS} \text{ at } 10 \text{ V} \qquad \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$	I _D	23			
Continuous Drain Current $(T_j = 150 \text{ C})$	$T_{\rm C} = 100 ^{\circ}{\rm C}$		15	А		
Pulsed Drain Current ^a	I _{DM}	58				
Linear Derating Factor			1.61	W/°C		
Single Pulse Avalanche Energy ^b		E _{AS}	353	mJ		
Maximum Power Dissipation	PD	202	W			
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope	T _J = 125 °C	dV/dt	70	- V/ns		
Reverse Diode dV/dt ^c		uv/ut	16	v/ris		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5 A.

c. $I_{SD} \leq I_D, \, dI/dt$ = 100 A/µs, starting T_J = 25 °C.

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THERMAL RESISTANCE RATI	NGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum Junction-to-Ambient	R _{thJA}	38		50					
Maximum Junction-to-Case (Drain)	R _{thJC}	0.48 0.62			°C/W				
SPECIFICATIONS (T _J = 25 °C, u	nless otherwi	se noted)							
PARAMETER	SYMBOL			ONS	MIN.	TYP.	MAX.	UNIT	
Static		•			•		•	1	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	50 µA	650	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I	_D = 1 mA	-	0.75	-	V/°C	
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 2	50 µA	2.0	-	4.0	V	
		Ņ	√ _{GS} = ± 20 \	/	-	-	± 100	nA	
Gate-Source Leakage	I _{GSS}	````	√ _{GS} = ± 30 \	/	-	-	± 1	μA	
		V _{DS} =	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$		-	-	1		
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 520 V	, V _{GS} = 0 V,	T _J = 125 °C	-	-	25	μA	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D	= 12 A	-	0.130	0.150	Ω	
Forward Transconductance	9 _{fs}	V _{DS}	= 30 V, I _D =	12 A	-	8.2	-	S	
Dynamic		•			•		•	1	
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$		-	2814	-		
Output Capacitance	C _{oss}	,	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$		-	121	-	1	
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	5	-	1		
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V_{DS} = 0 V to 520 V, V_{GS} = 0 V		-	88	-	pF		
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	365	-			
Total Gate Charge	Qg				-	77	116		
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	V _{GS} = 10 V I _D = 12 A, V _{DS} = 520 V		-	19	-	nC	
Gate-Drain Charge	Q _{gd}				-	33	-	1	
Turn-On Delay Time	t _{d(on)}		•		-	29	58		
Rise Time	t _r	V _{DD} =	520 V, I _D =	12 A,	-	59	71		
Turn-Off Delay Time	t _{d(off)}		$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	78	117	ns	
Fall Time	t _f				-	46	92	1	
Gate Input Resistance	Rg	f = 1 MHz, open drain		0.27	0.55	1.10	Ω		
Drain-Source Body Diode Characteristic	s								
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	23	A		
Pulsed Diode Forward Current	I _{SM}			-	-	58			
Diode Forward Voltage	V _{SD}	T _J = 25 °C	C, I _S = 12 A,	$V_{GS} = 0 V$	-	0.9	1.2	V	
Reverse Recovery Time	t _{rr}			10.4	-	436	872	ns	
Reverse Recovery Charge	Q _{rr}	T _J = 25 °C, I _F = I _S = 12 A, dl/dt = 100 A/μs, V _B = 25 V		-	7.4	14.8	μC		
Reverse Recovery Current	I _{RRM}		, vi		-	29	-	А	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

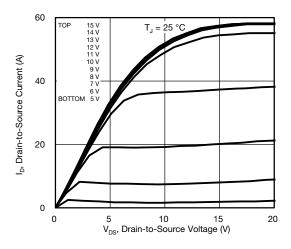


Fig. 1 - Typical Output Characteristics

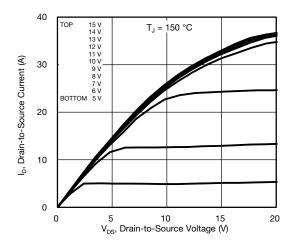
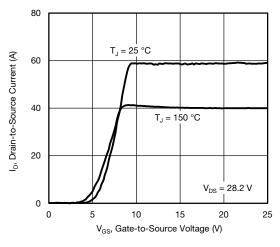


Fig. 2 - Typical Output Characteristics





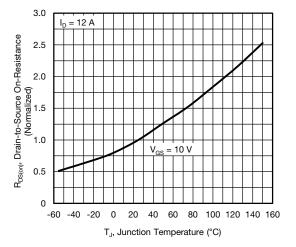


Fig. 4 - Normalized On-Resistance vs. Temperature

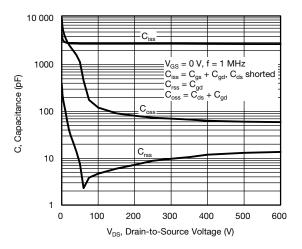


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

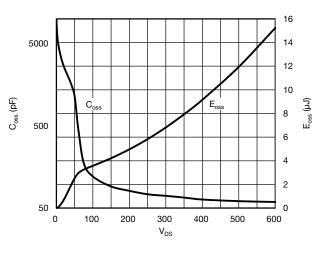


Fig. 6 - C_{OSS} and E_{OSS} vs. V_{DS}

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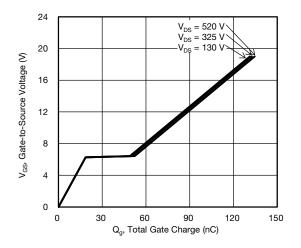


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

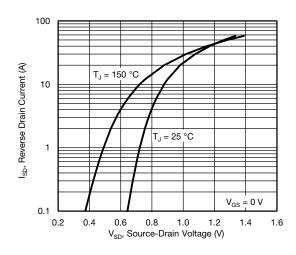


Fig. 8 - Typical Source-Drain Diode Forward Voltage

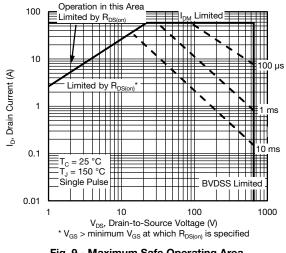


Fig. 9 - Maximum Safe Operating Area

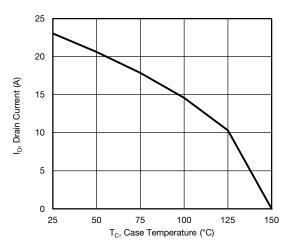


Fig. 10 - Maximum Drain Current vs. Case Temperature

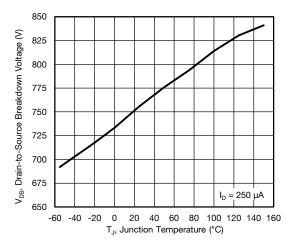


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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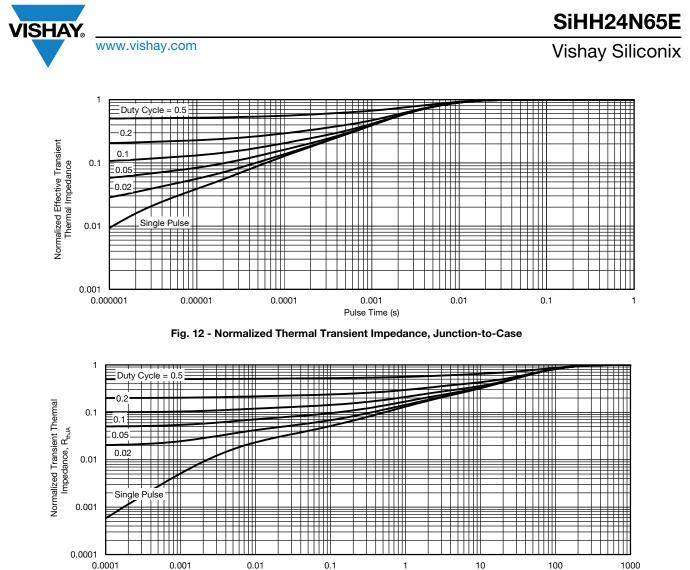


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

Pulse Time (s)

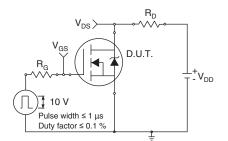


Fig. 14 - Switching Time Test Circuit

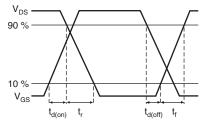
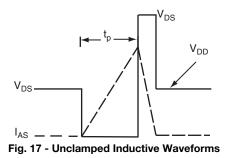


Fig. 15 - Switching Time Waveforms

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L V_{DS} M Vary t_p to obtain required I_{AS} D.U.T V_{DD} IAS 0 0.01 Ω tp

Fig. 16 - Unclamped Inductive Test Circuit

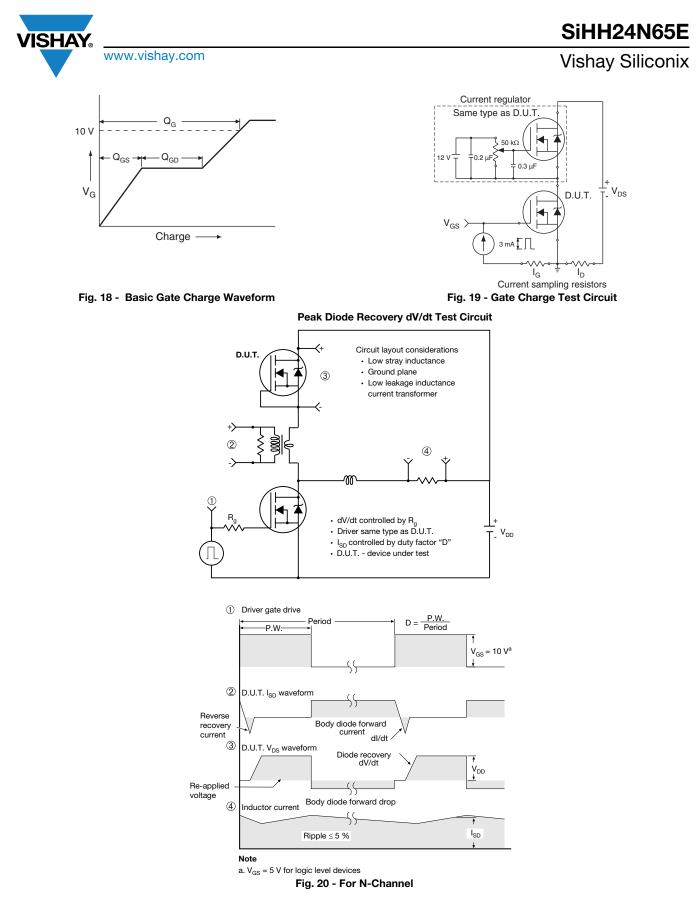


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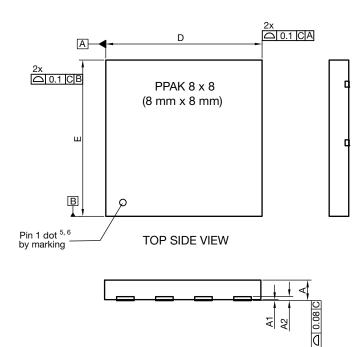


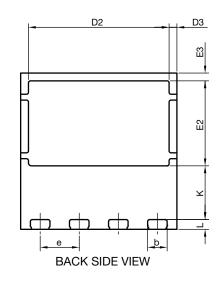
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PowerPAK[®] 8 x 8 Case Outline





DIM		MILLIMETERS			INCHES		
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.95	1.00	1.05	0.037	0.039	0.041	
A1	0.00	-	0.05	0.000	-	0.002	
A2		020 ref.		0.008 ref.			
b	0.95	1.00	1.05	0.037	0.039	0.041	
D	7.90	8.00	8.10	0.311	0.315	0.319	
D2	7.10	7.20	7.30	0.280	0.283	0.287	
D3		0.40 BSC		0.016 BSC			
е		2.00 BSC		0.079 BSC			
E	7.90	8.00	8.10	0.311	0.315	0.319	
E2	4.30	4.35	4.40	0.169	0.171	0.173	
E3		0.40 BSC		0.016 BSC			
К	2.75 BSC		0.108 BSC				
L	0.45	0.50	0.55	0.018	0.020	0.022	
N ⁽³⁾	8			8			

Notes

⁽¹⁾ Use millimeters as the primary measurement

⁽²⁾ Dimensioning and tolerances conform to ASME Y14.5 M - 1994

⁽³⁾ N is the number of terminals

⁽⁴⁾ The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body

⁽⁵⁾ Exact shape and size of this feature is optional

ECN: E20-0518-Rev. B, 28-Sep-2020 DWG: 6041

Revision: 28-Sep-2020

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Recommended Minimum PADs for PowerPAK[®] 8 mm x 8 mm



Dimensions in millimeters

Document Number: 68441



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